

# HCPL2530, HCPL2531 OPTOCOUPLEDERS/OPTOISOLATORS

SOOS016 D3115, APRIL 1988

- Compatible with TTL Inputs
- High-Speed Switching . . . 1 Mbit/s Typ
- Bandwidth . . . 2 MHz Typ
- High Common-Mode Transient Immunity . . . 1000 V/ $\mu$ s Typ
- High-Voltage Electrical Insulation . . . 3000 V DC Min
- Open-Collector Output
- UL Recognized . . . File Number 65085

## description

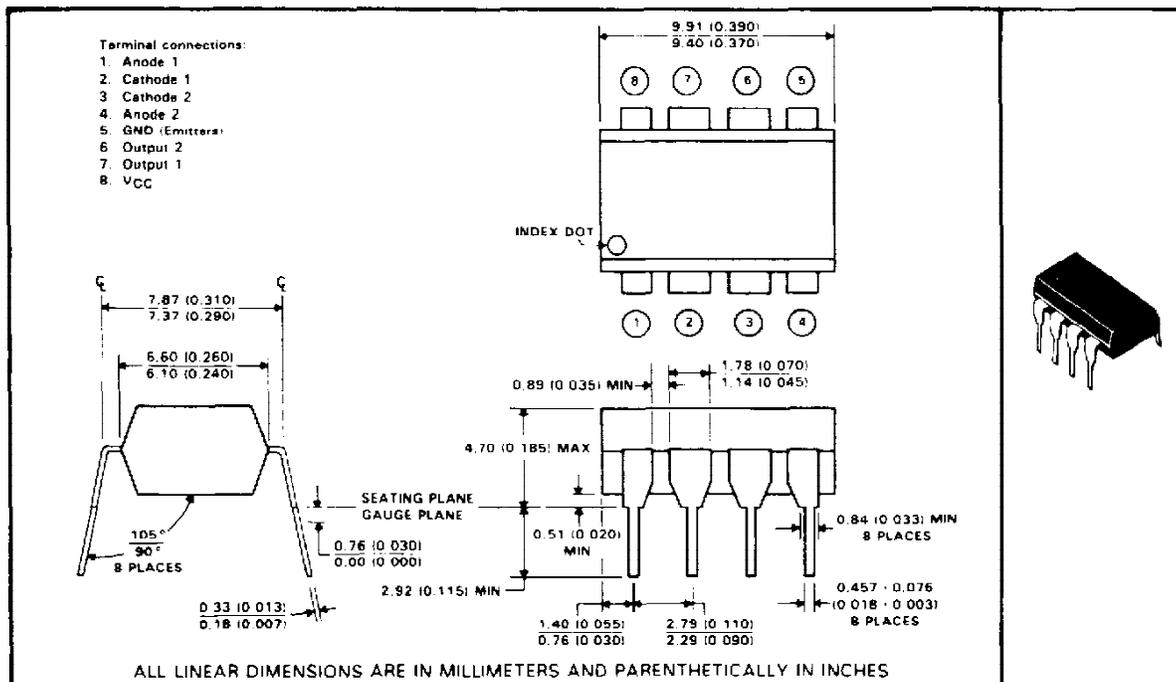
These high-speed optocouplers are designed for use in analog or digital interface applications that require high-voltage isolation between the input and output. Applications include line receivers that require high common-mode transient immunity, and analog or logic circuits that require input-to-output electrical isolation.

Each HCPL2530 and HCPL2531 optocoupler consists of two light-emitting diodes and two integrated photon detectors. Each detector is composed of a photodiode and an open-collector output transistor. Separate connections are provided for the photodiode bias and the transistor collector output. This feature, which reduces the transistor base-to-collector capacitance, results in speeds up to one hundred times that of a conventional phototransistor optocoupler.

The HCPL2530 is designed for TTL/CMOS, TTL/LSTTL, and wide-band analog applications.

The HCPL2531 is designed for high-speed TTL/TTL applications.

## mechanical data



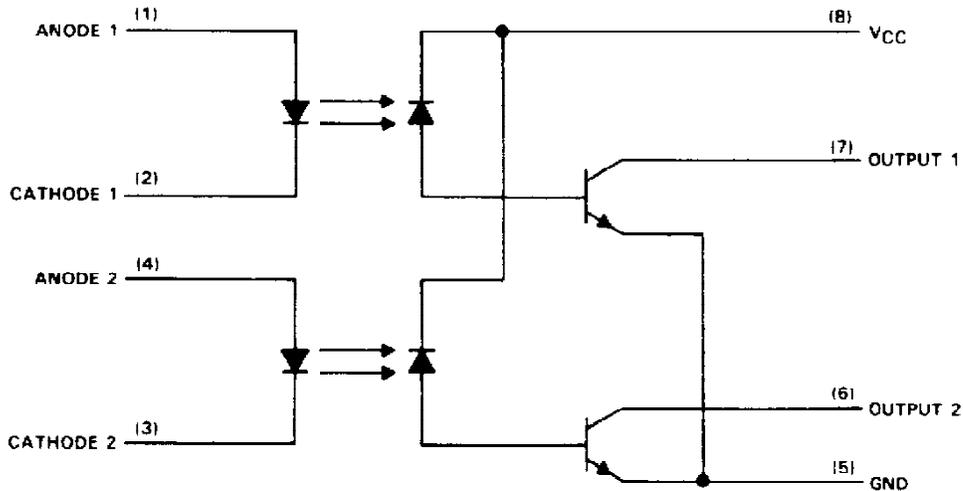
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**HCPL2530, HCPL2531  
OPTOCOUPLEDERS/OPTOISOLATORS**

schematic



**absolute maximum ratings at 25 °C free-air temperature (unless otherwise noted)**

Supply and output voltage range, $V_{CC}$ and $V_O$ .....	-0.5 V to 15 V
Reverse input voltage (each channel) .....	5 V
Peak input forward current (each channel) (pulse duration = 1 ms, 50% duty cycle, see Note 1) .....	50 mA
Peak transient input forward current (each channel) (pulse duration = 1 $\mu$ s, $f$ = 300 Hz) .....	1 A
Average forward input current (each channel) (see Note 2) .....	25 mA
Peak output current (each channel) .....	16 mA
Average output current (each channel) .....	8 mA
Input power dissipation at (or below) 70 °C free-air temperature (each channel) (see Note 3) .....	45 mW
Output power dissipation at (or below) 70 °C free-air temperature (each channel) (see Note 4) .....	35 mW
Storage temperature range .....	-55 °C to 125 °C
Operating free-air temperature range .....	-55 °C to 100 °C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds .....	260 °C

- NOTES: 1. Derate linearly above 70 °C free-air temperature at the rate of 1.67 mA/°C.  
 2. Derate linearly above 70 °C free-air temperature at the rate of 0.83 mA/°C.  
 3. Derate linearly above 70 °C free-air temperature at the rate of 1.50 mW/°C.  
 4. Derate linearly above 70 °C free-air temperature at the rate of 1.17 mW/°C.

## HCPL2530, HCPL2531 OPTOCOUPERS/OPTOISOLATORS

electrical characteristics over operating free-air temperature range of 0 °C to 70 °C (unless otherwise noted)

PARAMETER	TEST CONDITIONS	HCPL2530		HCPL2531		UNIT		
		MIN	TYP†	MAX	MIN		TYP†	MAX
V <sub>F</sub>	Input forward voltage	I <sub>F</sub> = 16 mA, T <sub>A</sub> = 25 °C		1.6	1.7	1.6	1.7	V
V <sub>F</sub>	Temperature coefficient of forward voltage	I <sub>F</sub> = 16 mA		-1.8		-1.8		mV/°C
V <sub>BR</sub>	Input breakdown voltage	I <sub>R</sub> = 10 μA, T <sub>A</sub> = 25 °C		5		5		V
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = 4.5 V, I <sub>F</sub> = 16 mA	I <sub>OL</sub> = 1.1 mA	0.1	0.5			V
			I <sub>OL</sub> = 2.4 mA			0.1	0.5	
I <sub>OH</sub>	High-level output current	I <sub>F1</sub> = I <sub>F2</sub> = 0, T <sub>A</sub> = 25 °C	V <sub>CC</sub> = V <sub>O1</sub> = V <sub>O2</sub> = 5.5 V	3	500	3	500	nA
		V <sub>CC</sub> = V <sub>O1</sub> = V <sub>O2</sub> = 15 V, I <sub>F1</sub> = I <sub>F2</sub> = 0			50		50	μA
I <sub>CCH</sub>	Supply current, high-level output	V <sub>CC</sub> = 15 V, I <sub>F1</sub> = I <sub>F2</sub> = 0	I <sub>O1</sub> = I <sub>O2</sub> = 0	4		4		μA
I <sub>CCL</sub>	Supply current, low-level output	V <sub>CC</sub> = 15 V, I <sub>F1</sub> = I <sub>F2</sub> = 16 mA	I <sub>O1</sub> = I <sub>O2</sub> = 0	80		80		μA
CTR	Current transfer ratio	V <sub>CC</sub> = 4.5 V, I <sub>F</sub> = 16 mA, See Note 5	V <sub>O</sub> = 0.5 V, T <sub>A</sub> = 25 °C	7%	18%	19%	24%	
		V <sub>CC</sub> = 4.5 V, I <sub>F</sub> = 16 mA, See Note 5	V <sub>O</sub> = 0.5 V, See Note 5	5%		15%		
r <sub>IO</sub>	Input-output resistance	V <sub>IO</sub> = 500 V, See Note 6	T <sub>A</sub> = 25 °C	10 <sup>12</sup>		10 <sup>12</sup>		Ω
I <sub>IO</sub>	Input-output insulation leakage current	V <sub>IO</sub> = 3000 V, See Note 6	t = 5 s, T <sub>A</sub> = 25 °C, R <sub>h</sub> = 45%	1		1		μA
C <sub>i</sub>	Input capacitance	V <sub>F</sub> = 0,	f = 1 MHz	60		60		pF
C <sub>io</sub>	Input-output capacitance	f = 1 MHz,	See Note 6	0.6		0.6		pF
r <sub>ii</sub>	Input-input resistance	V <sub>ii</sub> = 500 V, See Note 7	T <sub>A</sub> = 25 °C	10 <sup>11</sup>		10 <sup>11</sup>		Ω
I <sub>ii</sub>	Input-input insulation leakage current	V <sub>ii</sub> = 500 V, See Note 7	t = 5 s, T <sub>A</sub> = 25 °C, R <sub>h</sub> = 45%	0.005		0.005		μA
C <sub>ii</sub>	Input-input capacitance	f = 1 MHz, See Note 7	T <sub>A</sub> = 25 °C	0.25		0.25		pF

† All typical values are at T<sub>A</sub> = 25 °C.

NOTES: 5. Current transfer ratio is defined as the ratio of output collector current I<sub>O</sub> to the forward LED input current I<sub>F</sub> times 100%.

6. These parameters are measured between pins 2 and 3 shorted together and pins 5, 6, 7, and 8 shorted together.

7. These parameters are measured between pins 1 and 2 shorted together and pins 3 and 4 shorted together.

# HCPL2530, HCPL2531 OPTOCOUPLEDERS/OPTOISOLATORS

operating characteristics at  $V_{CC} = 5\text{ V}$ ,  $I_F = 16\text{ mA}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	HCPL2530			HCPL2531			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
BW	Bandwidth (–3 dB)	$R_L = 100\ \Omega$ , See Note 8			2			MHz

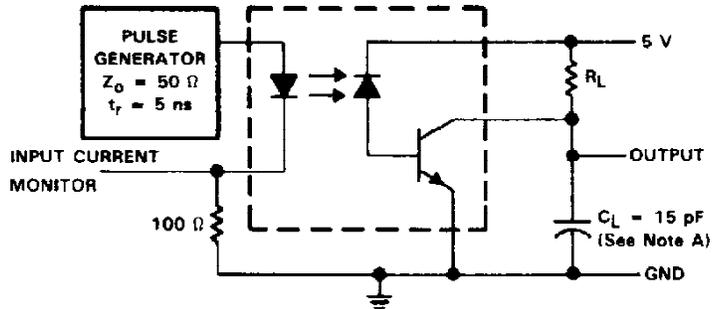
NOTE 7: Bandwidth is the range of frequencies within which the ac output voltage is not more than 3 dB below the low-frequency value.

switching characteristics at  $V_{CC} = 5\text{ V}$ ,  $I_F = 16\text{ mA}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

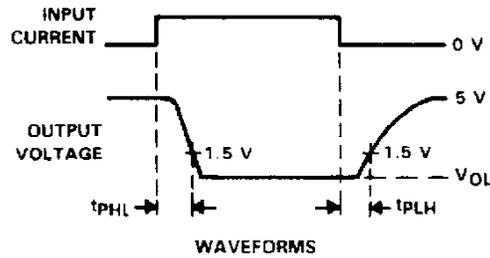
PARAMETER	TEST CONDITIONS	HCPL2530			HCPL2531			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
$t_{PLH}$	Propagation delay time, low-to-high-level output	$R_L = 4.1\text{ k}\Omega$ , See Note 9, See Figure 1		1.0	1.5			$\mu\text{s}$
		$R_L = 1.9\text{ k}\Omega$ , See Note 10, See Figure 1				0.6	0.8	
$t_{PHL}$	Propagation delay time, high-to-low-level output	$R_L = 4.1\text{ k}\Omega$ , See Note 9, See Figure 1		0.7	1.5			$\mu\text{s}$
		$R_L = 1.9\text{ k}\Omega$ , See Note 10, See Figure 1				0.6	0.8	
$\frac{dV_{CM}}{dt}$ (H)	Common-mode input transient immunity, high-level output	$\Delta V_{CM} = 10\text{ V}$ , $I_F = 0$ , $R_L = 4.1\text{ k}\Omega$ , See Notes 9 and 10, See Figure 2		1000			$\text{V}/\mu\text{s}$	
		$\Delta V_{CM} = 10\text{ V}$ , $I_F = 0$ , $R_L = 1.9\text{ k}\Omega$ , See Notes 10 and 11, See Figure 2		1000				
$\frac{dV_{CM}}{dt}$ (L)	Common-mode input transient immunity, low-level output	$\Delta V_{CM} = 10\text{ V}$ , $R_L = 4.1\text{ k}\Omega$ , See Figure 2, See Notes 9 and 11,		–1000			$\text{V}/\mu\text{s}$	
		$\Delta V_{CM} = 10\text{ V}$ , $R_L = 1.9\text{ k}\Omega$ , See Figure 2, See Notes 10 and 11		–1000				

- NOTES:
9. The 4.1-k $\Omega$  load represents one LSTTL unit load of 0.36 mA and a 6.1-k $\Omega$  pullup resistor.
  10. The 1.9-k $\Omega$  load represents one TTL unit load of 1.6 mA and a 5.6-k $\Omega$  pullup resistor.
  11. Common-mode transient immunity, high-level output, is the maximum rate of rise of the common-mode input voltage that does not cause the output voltage to drop below 2 V. Common-mode input transient immunity, low-level output, is the maximum rate of fall of the common-mode input voltage that does not cause the output voltage to rise above 0.8 V.

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT (EACH CHANNEL)

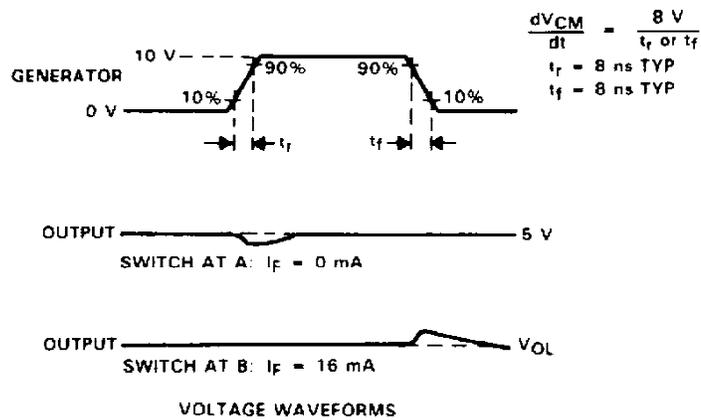
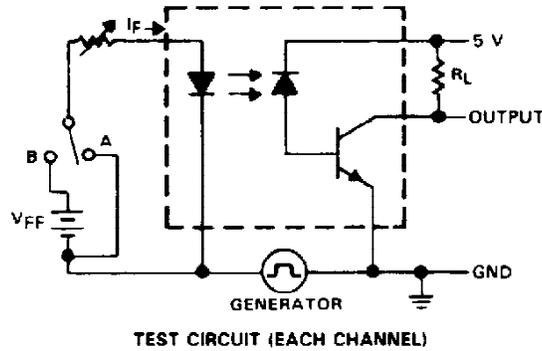


NOTE A:  $C_L$  includes probe and stray capacitance.

FIGURE 1. SWITCHING TEST CIRCUIT AND WAVEFORMS

**HCPL2530, HCPL2531  
OPTOCOUPLEDERS/OPTOISOLATORS**

**PARAMETER MEASUREMENT INFORMATION**



**FIGURE 2. TRANSIENT IMMUNITY TEST CIRCUIT AND WAVEFORMS**

# HCPL2530, HCPL2531 OPTOCOUPLEDERS/OPTOISOLATORS

INPUT DIODE FORWARD CURRENT  
vs  
FORWARD VOLTAGE

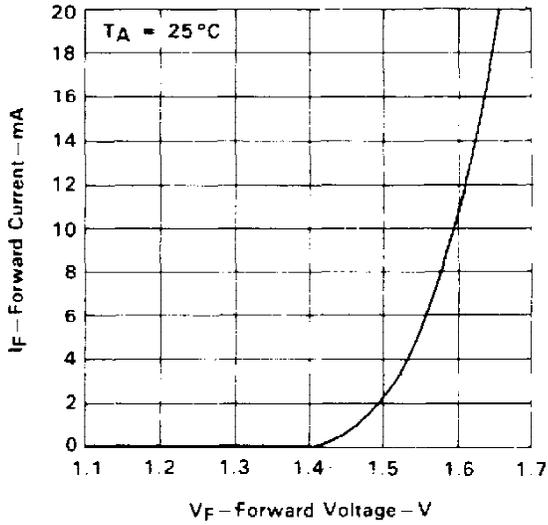


FIGURE 3

HCPL2530  
CURRENT TRANSFER CHARACTERISTICS

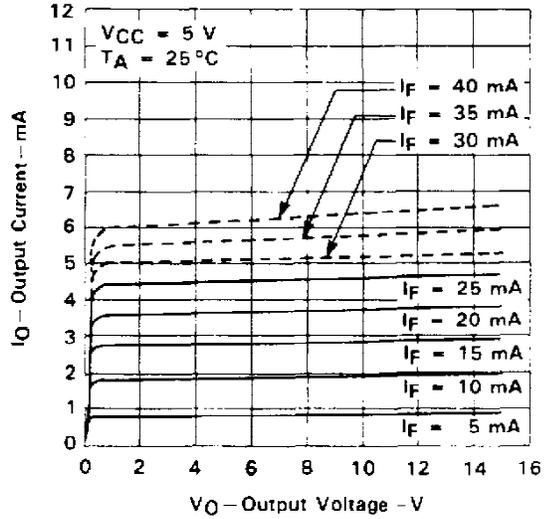


FIGURE 4

NORMALIZED CURRENT TRANSFER RATIO  
vs  
INPUT DIODE FORWARD CURRENT

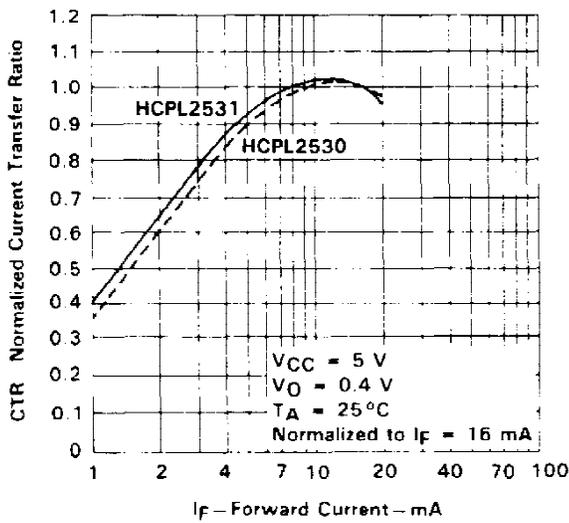


FIGURE 5

NORMALIZED CURRENT TRANSFER RATIO  
vs  
FREE AIR TEMPERATURE

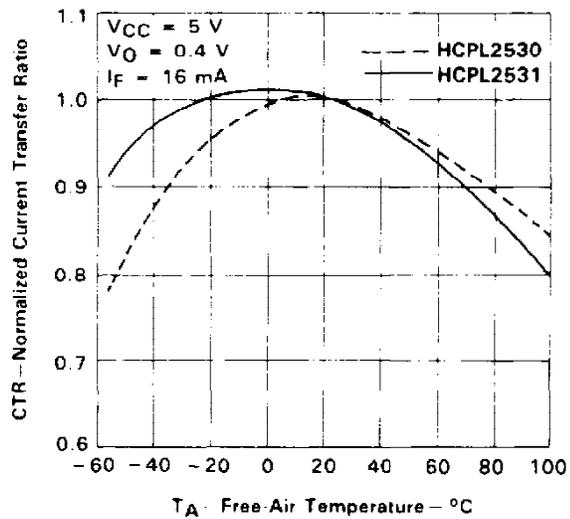


FIGURE 6

**HCPL2530, HCPL2531**  
**OPTOCOUPERS/OPTOISOLATORS**

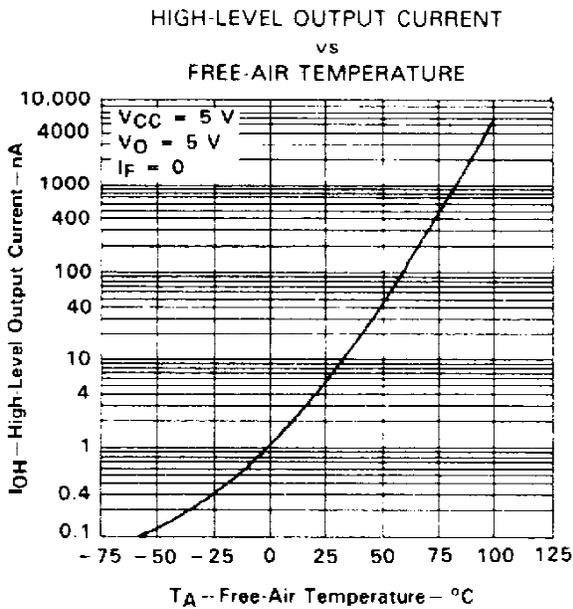


FIGURE 7

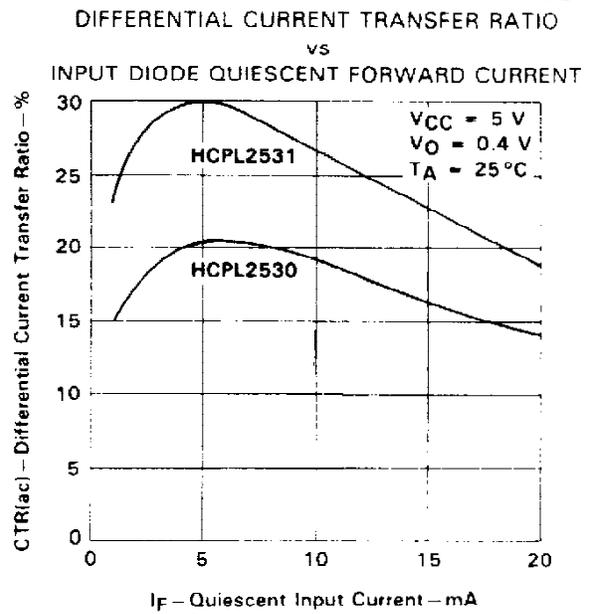


FIGURE 8

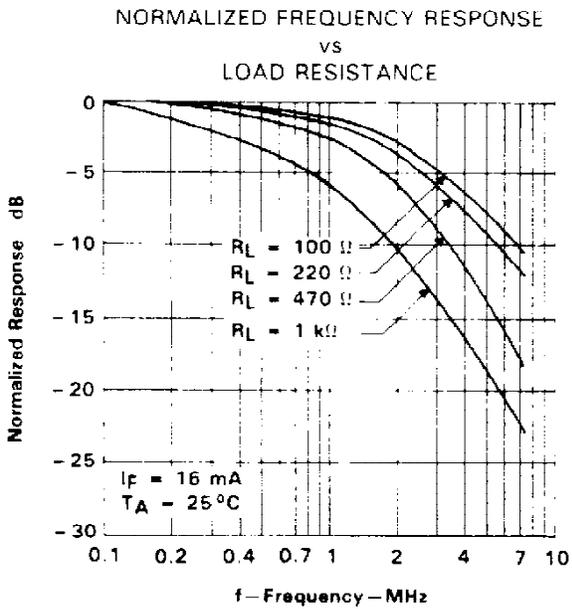


FIGURE 9

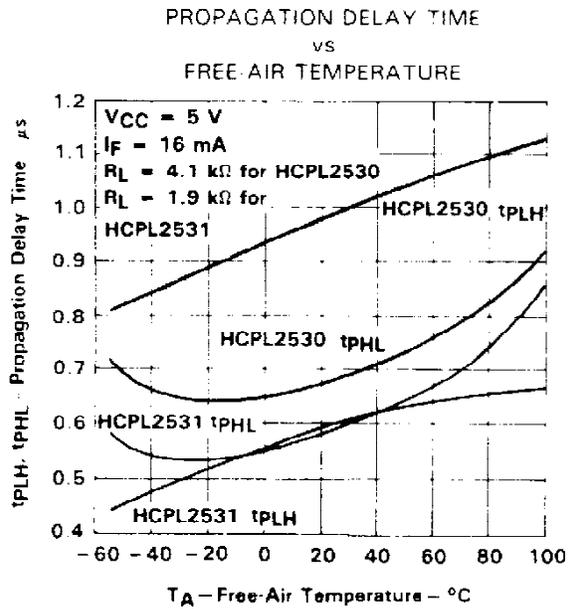


FIGURE 10

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